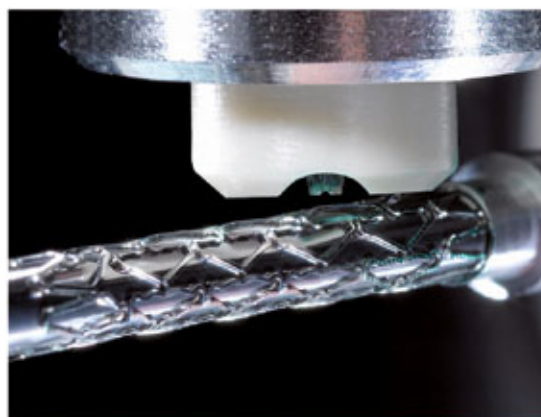


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J.G. Korvink,
P.J. Smith,
D.-Y. Shin



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